

LENOO 聯宇電子股份有限公司

LENOO ELECTRONICS CO., LTD.

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APPROVAL SHEET

CUSTOMER: _____

CUSTOMER PART NO. _____

TYPE NO.: L034GT

PACKAGE SIZE: 3mm Round Type LED Lamps

DICE MATERIAL: GaP PEAK WAVE LENGTH(nm) 568

EMITTED COLOR: Green VIEWING ANGLE (deg): 36

LENS COLOR: Green Transparent IV(mcd): 130

CUSTOMER
ENGINEERING DEPARTMENT

LENOO ELECTRONICS CO., LTD.
ENGINEERING DEPARTMENT

(Authorized Signature)

APPROVED DATE _____

ISSUED DATE _____

LENOO ELECTRONICS CO., LTD.

TYPE NO. : L034GT

ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta = 25°C

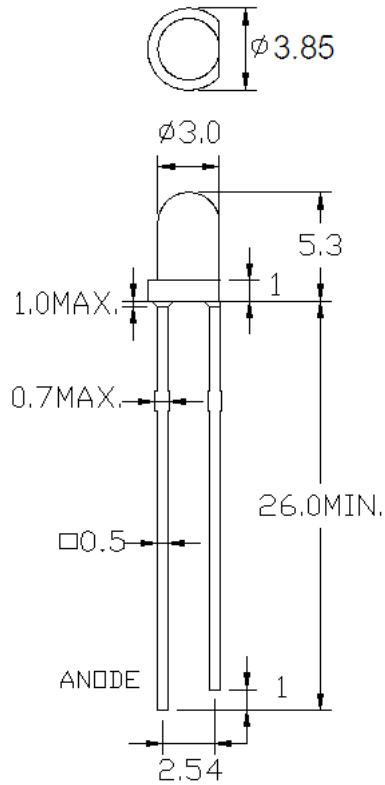
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST
Luminous Intensity	IV	80	130	160	mcd	IF = 20mA
Viewing Angle	2 θ 1/2		36		deg	
Peak Emission Wavelength	λ_p		568		nm	
Dominant Wavelength	λ_D	566	570	573	nm	
Spectral Line Half-Width	$\Delta\lambda$		30		nm	
Forward Voltage	VF	1.9	2.2	2.6	V	
Power Dissipation	Pd			85	mW	
Peak Forward Current (Duty1/10 @ 1KHZ)	IF (Peak)			100	mA	
Recommended Operating Current	IF (Rec)		20		mA	

● ABSOLUTE MAXIMUM RATINGS : (Ta = 25°C)

Reverse Voltage	: 5 Volt
Reverse Current	: 10 uA (VR=5V)
Operating Temperature Range	: -40°C TO 85°C
Storage Temperature Range	: -40°C TO 100°C
Lead Soldering Temperature Range 【 1.6 mm (1/16 inch) from body 】	: 260°C For 5 Seconds

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LED LAMPS PACKAGE DIMENSIONS



Unit: mm

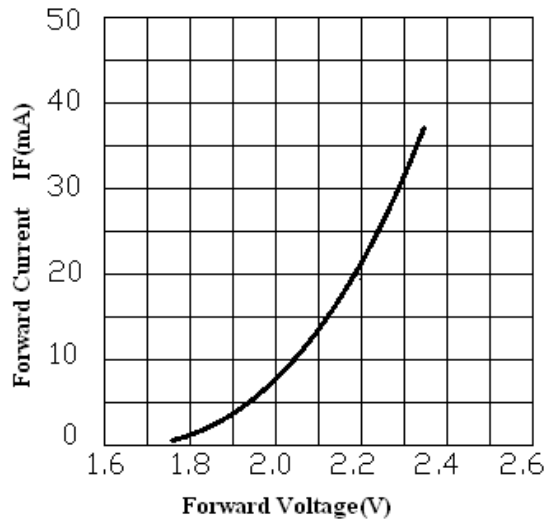
DEVICE NO.:L034GT	DRAWING NO.	ENGINEER
ALL TOLERANCE SHALL BE ± 0.01 inch/0.25mm UNLESS OTHERWISE NOTED	DRAWING DATE	APPROVER

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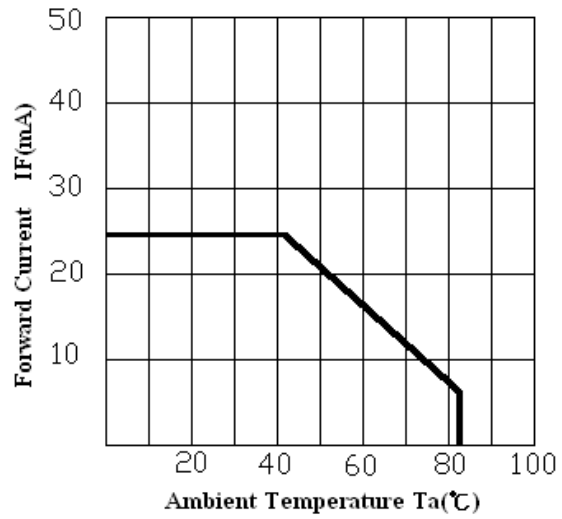
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Typical Electro-Optical Characteristics Curves

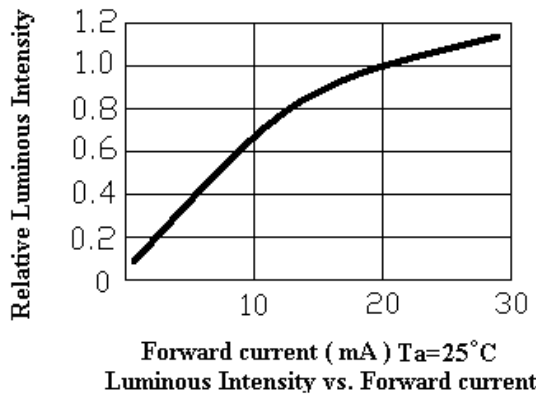
Green (GaP $\lambda_P=568\text{nm}$)



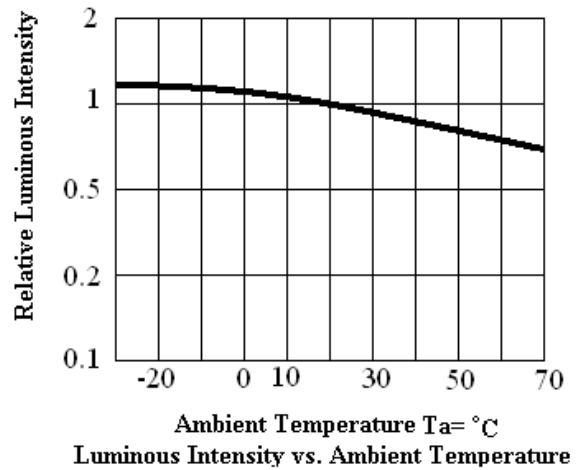
Forward Current vs. Forward Voltage



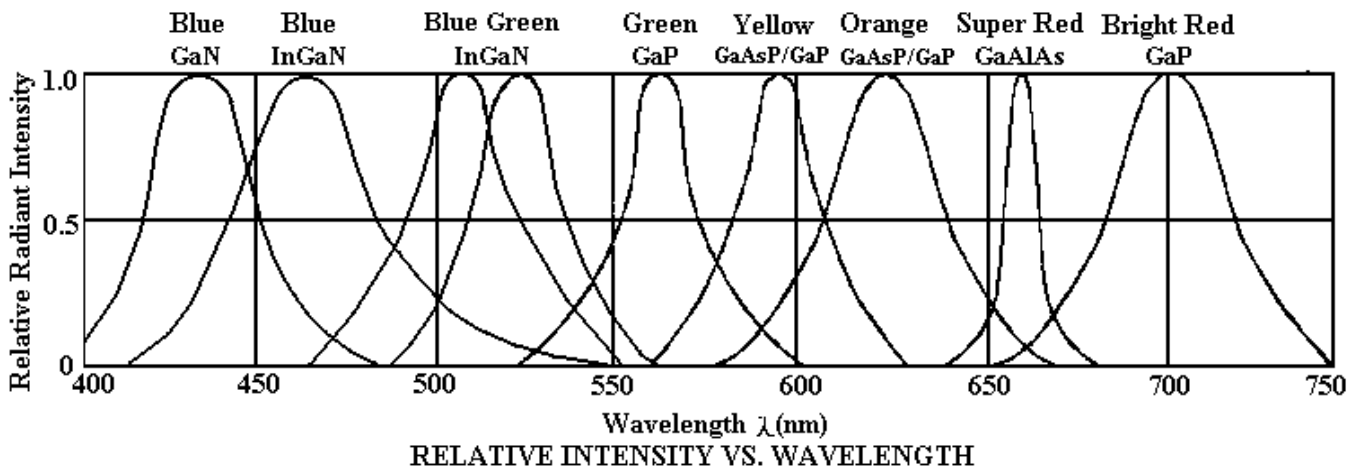
Forward Current Derating Curve



Luminous Intensity vs. Forward current



Luminous Intensity vs. Ambient Temperature



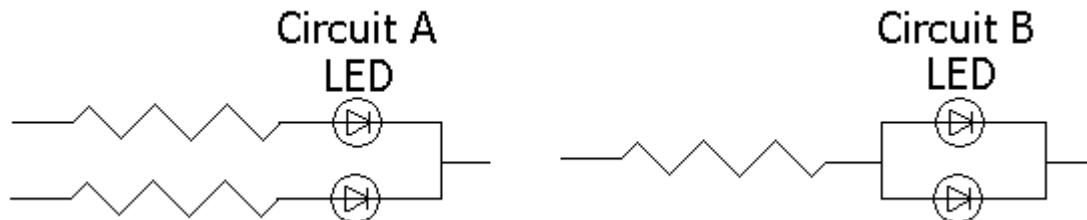
RELATIVE INTENSITY VS. WAVELENGTH

Reliability test For LED Lamps**Type No. :L034GT**

NO.	Item	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25°C IF:20mA	1000HRS	20PCS	0/1
2	High Temperature High Humidity	Temperature:85°C 85%RH	1000HRS	20PCS	0/1
3	High Temperature Storage	Temperature:100°C	1000HRS	20PCS	0/1
4	Low Temperature Storage	Temperature: -40°C	1000HRS	20PCS	0/1
5	Temperature Cycling	85°C~25°C~-35°C 15min~5min~15min	15Cycles	20PCS	0/1
6	Thermal Shock	85°C~25°C~-10°C 5min~10sec~5min	15Cycles	20PCS	0/1
7	Solder Heat	Temperature:260°C±5°C	10SEC.	20PCS	0/1

Precautions For Use LED**1. Drive Method**

LED is current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in a application, it is recommended that a current limiting resistor be incorporated in the drive circuit.



(a) Circuit A it is recommended circuit.

(b) Circuit B the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

2. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change(Burn out will happen).

3. Storage

The Storage Temperature and RH are: 5°C ~ 30°C, RH 60% or less.

Once the package is opened, the products should be used with in a week. Otherwise, they should be kept in moisture proof package with moisture absorbent material (silica gel).

we suggest our customers to use our products within a year.

If the moisture absorbent material (silica gel) has faded away or the LEDs exceeded the storage time , baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at 60°C ±5°C.

4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs

Suggestions to prevent ESD damage:

Use of a conductive wrist band or ante-electrostatic glove when handing these LEDs

All devices, equipment, and machinery must be properly grounded.

Work tables storage racks, etc. should be properly grounded

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

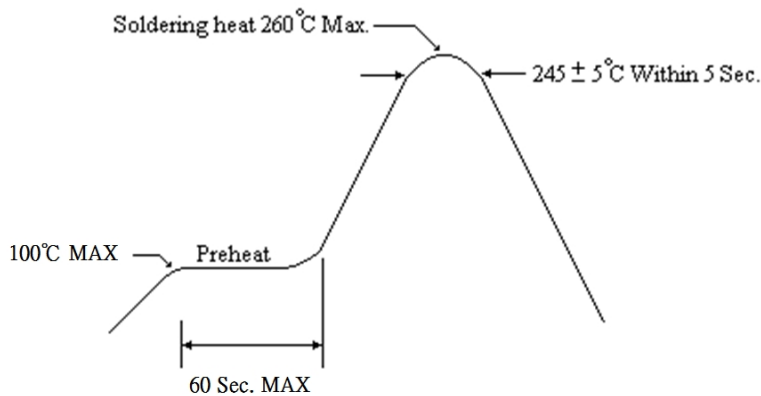
5. Others

- (a) If want to have the uniform luminance and color, please use the same binning number, and avoid using intermix to cause the differences of luminance and color.
- (b) The appearance and specifications of the product may be modified for improvement without prior notice.

6. Soldering

Recommended soldering condition as shown below:

Soldering heat (DIP)



Soldering Iron

Temperature at tip of iron : 350°C Max.

Soldering Time: 3 sec. ± 1 sec. (one time only)

If temperature is higher, time should be shorter

Reflow Temp./Time(SMD)

